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1 Scope

The present document describes the SPI interface for the communication of an SSP, as defined in ETSI TS 103 666-1 [1] using the SCL protocol.

2 References

2.1 Normative references

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The following referenced documents are necessary for the application of the present document.

- [1] ETSI TS 103 666-1: "Smart Secure Platform (SSP); Part 1: General characteristics".
- [2] ETSI TS 102 613: "Smart Cards; UICC Contactless Front-end (CLF) Interface; Physical and data link layer characteristics".
- [3] ISO/IEC 13239: "Information Technology Telecommunications and information exchange between systems High-level Data Link Control (HDLC) procedures".

2.2 Informative references

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The following referenced documents are not necessary for the application of the present document but they assist the user with regard to a particular subject area.

[i.1] ETSI TR 102 216: "Smart cards; Vocabulary for Smart Card Platform specifications".

3 Definition of terms, symbols and abbreviations

3.1 Terms

For the purposes of the present document, the terms given in ETSI TR 102 216 [i.1] and the following apply:

data transfer: information exchange during an SPI access between the master and the slave with SPI_MISO driven by the slave and SPI_MOSI driven by the master while the master is toggling the SPI_CLK signal

flow control: mechanism part of the Data Link Layer that consists of methods applied by transmitter in order to send at any time a number of logical data units that can be accepted by receiver

frame: link layer data structure consisting of a prologue or frame header, payload and epilogue or trailer usually containing the CRC bytes

MAC access request: request from the slave to the master for a data transfer, i.e. a MAC phase initiated by the slave

MAC phase: initiation of a data transfer by the master and/or request for a data transfer by the slave

SPI access: SPI_NSS assertion by the master, if not already asserted in the MAC phase, followed by SPI_CLK start for transferring a certain number of bytes according to the SPI master configuration

NOTE: The number of bytes transferred during an SPI access is always the same in both directions on SPI_MISO and SPI_MOSI and is also referred to as access length.

window size: maximum number of logical data units that can be sent from transmitter to receiver without any link layer acknowledgements for any of these data units

window size slot: fixed space allocated by slave in the receive buffer for the logical data units used for windows size definition

NOTE: The length of a window size slot equals Data Link Layer MTU.

3.2 Symbols

Void.

3.3 Abbreviations

For the purposes of the present document, the following abbreviations apply:

AC Alternating Current
ACT Activation

CLF ContactLess Frontend

CMD Command
CPHA Clock Phase
CPOL Clock Polarity

CRC Cyclic Redundancy Check

DC Direct Current
DLL Data Link Layer
FIFO First In, First Out
IO Input/Output

IOH High Output Current (Output current corresponding to VOH)
IOL Low Output Current (Output current corresponding to VOL)

LLC Logical Link Control
LPDU Link Protocol Data Unit
MAC Medium Access Control
MCT MAC aCTivation

MISO Master Input Slave Output MOSI Master Output Slave Input

MTU	Maximum Transmission Unit
NSD	Non-Significant Data
OD	Open Drain
RFU	Reserved for Future Use
SCL	SSP Common Layer
SHDLC	Simplified High Level Data Link Control
SPI	Serial Peripheral Interface
SSP	Smart Secure Platform
SWP	Single Wire Protocol
NOTE:	Defined in ETSI TS 102 613 [2].
VDD	Supply Voltage
VIH	High Input Voltage (Input Voltage for High Logic Level)
VIL	Low Input Voltage (Input Voltage for Low Logic Level)
VOH	High Output Voltage (Output Voltage for High Logic Level)
VOL	Low Output Voltage (Output Voltage for Low Logic Level)

4 Introduction

The Serial Peripheral Interface (SPI) is a serial synchronous full-duplex communication interface between a single master and one or more slaves present on the same SPI bus, each slave being selected at one time by a dedicated SPI_NSS signal. This clause defines the physical, MAC and data link layers for the SPI interface.

In this clause the terms master and slave refer respectively to the terms master SPI and slave SPI.

5 SCL Under-Layers Protocol Stack

Figure 5.1 illustrates the protocol stack below the SCL supporting the SPI interface.

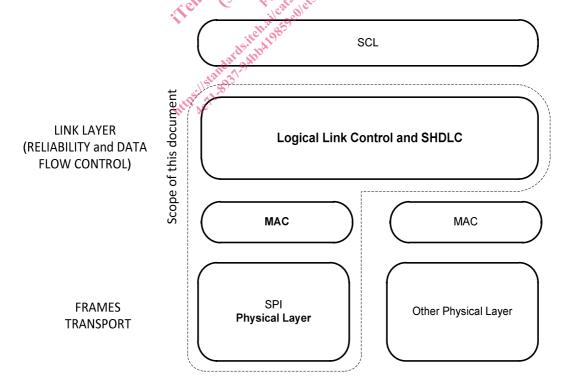


Figure 5.1: Protocol stack for SPI Interface

6 Electrical interfaces

6.1 Introduction

In the clauses below, different implementations of SPI interface are defined. These implementations allow bi-directional communication and the possibility for the slave to initiate communication with the master when it has data available thus avoiding the necessity for continuous polling to be performed by master.

Slave may initiate communication to send a command without a prior command from master.

6.2 Physical interface with 5 signals

Figure 6.1 illustrates the SPI electrical interface using 5 signals.

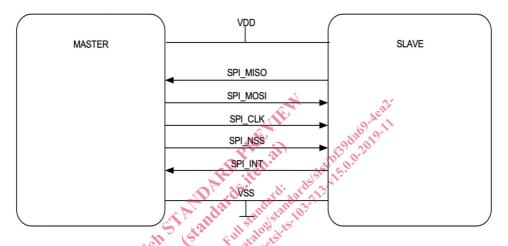


Figure 6.1: SPI electrical interface with 5 signals

This SPI interface describes two sets of signals:

- The generic and legacy SPI interface using the 4 signals: SPI_MOSI (Master Output Slave Input), SPI_MISO (Master Input Slave Output), SPI_CLK (clock) and the SPI_NSS signal used for the selection of a Slave Endpoint among N slaves sharing the same bus. SPI_MISO, SPI_MOSI and SPI_CLK can be shared between several SPI slaves present on the same SPI bus.
- The SPI_INT signal allows the slave to initiate a MAC access request in order to notify the master to start a data transfer.

SPI_INT signal is considered active or asserted at high voltage level.

SPI_NSS is considered active or asserted at low voltage level.

6.3 Physical interface with 4 signals

Figure 6.2 illustrates the SPI interface using 4 signals, bi-directional SPI_NSS.

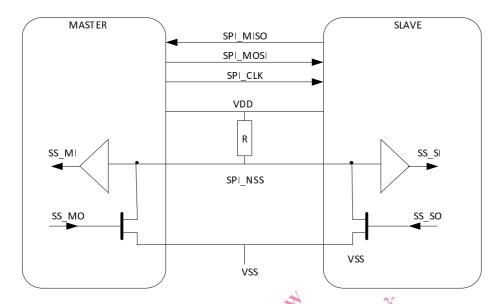


Figure 6.2: SPI electrical interface with 4 signals, bi-directional SPI_NSS

The SPI interface with 4 signals describes two sets of signals:

- The three generic and legacy SPI signals as SPI_MOSI (Master Output Slave Input), SPI_MISO (Master Input Slave Output) and SPI_CLK (clock). These signals can be shared between several SPI slaves as a bus.
- The SPI_NSS (Negative Slave Select) signal used for the selection of a slave endpoint among N slaves sharing the same bus and for the slave to initiate a MAC access request to notify the master to initiate a data transfer.

SPI_NSS is considered active or asserted at low voltage level. SPI_NSS requires a bidirectional IO implementing an Open Drain (OD) interface for both master and slave. This configuration allows driving the SPI_NSS signal to low voltage level by both master and slave without electrical contention.

A pull-up resistor allows to keep SPI_NSS at high state level (i.e. idle state) when SS_MO and SS_SO are not asserted. The SPI_NSS signal is at low state when either SS_MO or SS_SO are asserted.

NOTE: Despite the current industry de-facto SPI specification which defines SPI_NSS signal as unidirectional, driven by the master, in the present document the SPI_NSS in the 4 signals configuration is bidirectional.

Table 6.1: Definition of the signals

Signal	Description
SS_MO	Internal master output signal for SPI_NSS assertion. SS_MO is at high state level for
	generating a SPI_NSS signal assertion (i.e. low level state)
SS_SO	Internal slave output signal for SPI_NSS assertion. SS_SO is at high state level for
	generating a SPI_NSS signal assertion (i.e. low level state)
SS_MI	Internal master input signal indicating SPI_NSS status. SS_MI is at high state level when
	the SPI_NSS signal is not asserted
SS_SI	Internal slave input signal indicating SPI_NSS status. SS_SI is at high state level when
	the SPI_NSS signal is not asserted
SPI_NSS	SPI_NSS signal: low state level when asserted